



### **DUAL COMPLEMENTARY PRE-BIASED TRANSISTORS**

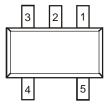
### **Features**

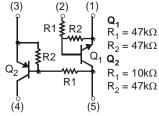
- Ultra-Small Surface Mount Package
- Surface Mount Package Suited for Automated Assembly
- Simplifies Circuit Design and Reduces Board Space
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Mechanical Data**

- Case: SOT353
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (a)
- Weight: 0.006 grams (Approximate)







Package Pin Out Configuration

Device Schematic

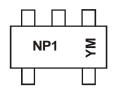
## Ordering Information (Notes 4 & 5)

Part Number	Compliance	Marking	Reel Size (inch)	Tape Width (mm)	Quantity per Reel
UMC4NQ-7	Automotive	NP1	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



NP1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	2017	20	18	2019	20120	20	21	2022	2023	20	24	2025
Code	E	F	=	G	Н		I	J	K		L	М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## Absolute Maximum Ratings, Pre-Biased NPN Transistor, Q<sub>1</sub> (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	Vcc	50	V
Input Voltage	V <sub>IN</sub>	-10 to +40	V
Output Current	l <sub>0</sub>	30	mA
Collector Current	Ic	100	mA

## Absolute Maximum Ratings, Pre-Biased PNP Transistor, Q<sub>2</sub> (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V <sub>CC</sub>	-50	V
Input Voltage	V <sub>IN</sub>	-40 to +6	V
Output Current	lo	-100	mA
Collector Current	Ic	-100	mA

## Thermal Characteristics (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	$P_{D}$	290	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	430	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Note:

## Electrical Characteristics, Pre-Biased NPN Transistor, Q<sub>1</sub> (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	(Note 7)	$V_{I(OFF)}$	0.5		_	V	$V_{CC} = 5V, I_{O} = 100 \mu A$
Input voltage	(Note 8)	V <sub>I(ON)</sub>		_	3	V	$V_O = 0.3V$ , $I_O = 2mA$
Output Voltage		V <sub>O(ON)</sub>		0.1	0.3	V	$I_{O} / I_{I} = 10 \text{mA} / 0.5 \text{ mA}$
Input Current		II		_	0.18	mA	$V_I = 5V$
Output Current		I <sub>O(OFF)</sub>	_	_	0.5	μΑ	$V_{CC} = 50V, V_I = 0V$
DC Current Gain		Gı	68	_	_	_	$V_{O} = 5V, I_{O} = 5mA$
Gain-Bandwidth Product (Note 9)		f⊤	_	250	_	MHz	$V_{CE} = 10V$ , $I_{E} = -5mA$ , $f = 100MHz$
Input Resistance		R <sub>1</sub>	32.9	47	61.1	kΩ	_
Resistance Ratio		R <sub>2</sub> /R <sub>1</sub>	0.8	1	1.2	_	_

Notes:

- 7. The device is guaranteed to be in "OFF" state with  $V_{\text{I(OFF)}}$  up to 0.5V.
- 8. The device is guaranteed to be in "ON" state with  $V_{I(ON)}$  starting from 3V.
- 9. Characteristic of Transistor for reference only.

## Electrical Characteristics, Pre-Biased PNP Transistor, Q2 (@TA = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	(Note 10)	V <sub>I(OFF)</sub>	-0.3	_	_	>	$V_{CC} = -5V$ , $I_{O} = -100\mu A$
input voltage	(Note 11)	V <sub>I(ON)</sub>	_	_	-1.4	V	$V_O = -0.3V$ , $I_O = -1mA$
Output Voltage		V <sub>O(ON)</sub>	_	-0.1	-0.3	>	$I_0/I_1 = -5\text{mA}/-0.25 \text{ mA}$
Input Current		lı	_	_	-0.88	mA	$V_I = -5V$
Output Current		I <sub>O(OFF)</sub>	_	_	-0.5	μΑ	$V_{CC} = -50V, V_{I} = 0V$
DC Current Gain		Gı	68	_	_		$V_0 = -5V, I_0 = -5mA$
Gain-Bandwidth Product (Note 9)		f <sub>T</sub>	_	250		MHz	$V_{CE} = -10V$ , $I_E = 5mA$ , $f = 100MHz$
Input Resistance		R <sub>1</sub>	7	10	13	kΩ	_
Resistance Ratio		R <sub>2</sub> /R <sub>1</sub>	3.7	4.7	5.7	_	_

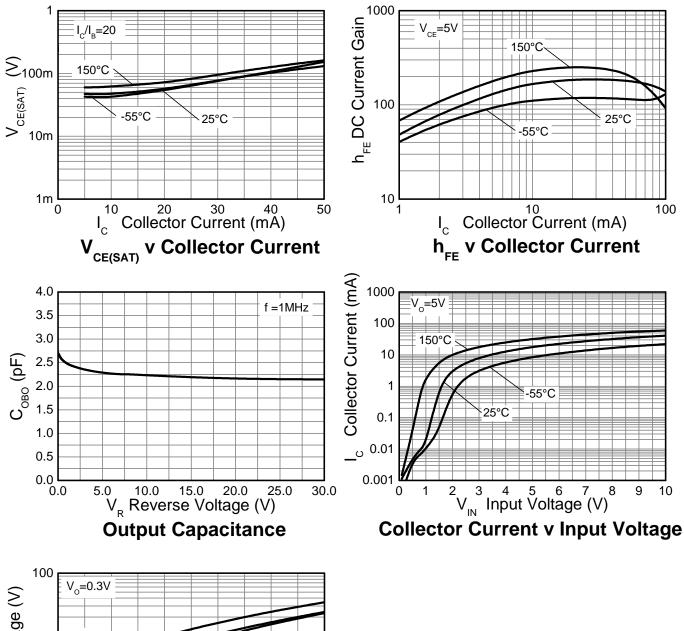
Notes:

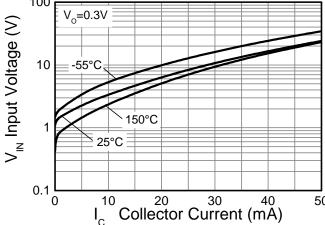
- 10. The device is guaranteed to be in "OFF" state with  $V_{I(OFF)}$  up to -0.3V.
- 11. The device is guaranteed to be in "ON" state with  $V_{I(ON)}$  starting from -1.4V.

<sup>6.</sup> For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.



# Typical Electrical Characteristics – NPN Section (@T<sub>A</sub> = +25°C, unless otherwise specified.)

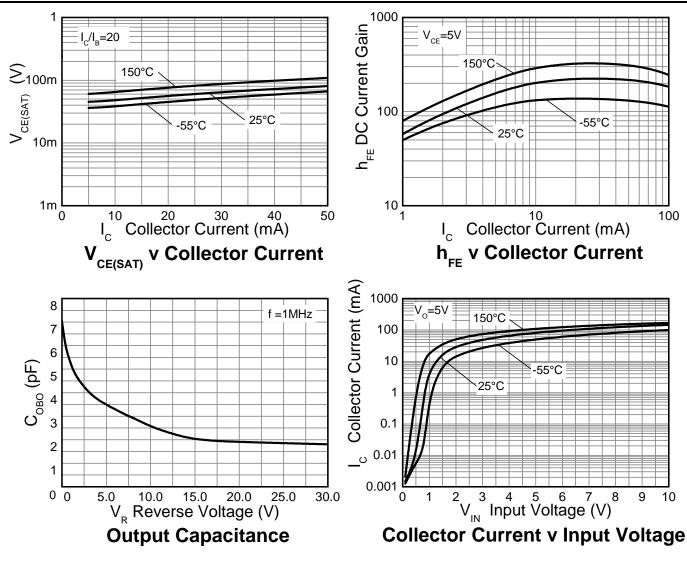


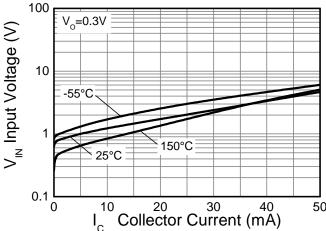


**Input Voltage v Collector Current** 



# Typical Electrical Characteristics – PNP Section (@TA = +25°C, unless otherwise specified.)





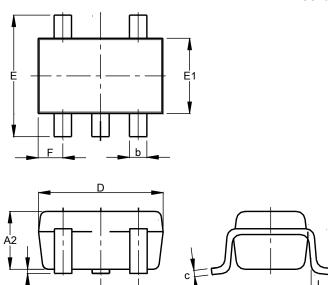
**Input Voltage v Collector Current** 



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT353**

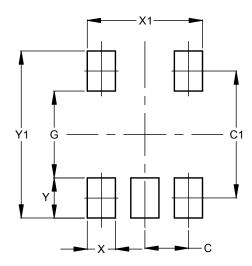


SOT353								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	1.00					
b	0.10	0.30	0.25					
C	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C	).650 B	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All Dimensions in mm								

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT353**



Dimensions	Value
Dillielisions	(in mm)
С	0.650
C1	1.900
G	1.300
Х	0.420
X1	1.720
Υ	0.600
Y1	2.500



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